

# *Contents*

<b>1. The Chemistry and Physics of Solid Adhesion</b>	
<i>Lieng-Huang Lee</i>	
1. Introduction .....	1
2. The Four Forces of Nature .....	2
2.1. Carriers of Four Forces .....	3
2.2. Gluons and Adhesion of Nuclei .....	4
2.3. Nuclear Equation of State .....	5
3. Chemical Bonding and Intermolecular Forces .....	6
3.1. Chemical Forces and Covalent Bonding .....	6
3.2. Coulomb Force and Ionic Bond .....	6
3.3. Electronegativity and Partial Ionic Bond .....	7
3.4. Lifshitz–van der Waals Forces Between Microscopic Bodies .....	8
3.5. Nonretarded Lifshitz–van der Waals Forces Between Macroscopic Bodies .....	11
4. Molecular Interactions .....	16
4.1. Morse Interaction Curve .....	16
4.2. Perturbation Theory .....	17
4.3. Kitaura–Morokuma’s Decomposition of Interaction Energies .....	18
4.4. Natural Bond Orbital (NBO) Donor–Acceptor Approach .....	19
4.5. Acid–Base Interaction .....	21
5. Role of Diffusion in Adhesion .....	23
5.1. Fick’s Laws of Diffusion .....	23
5.2. Activation Energy of Diffusion .....	24
5.3. Diffusion and Adhesion of Polymers .....	24
5.4. Diffusion of Solid into Polymers .....	26
6. Physicochemical Bonding on Solid Surfaces .....	26
6.1. Density of States (DOS) .....	26
6.2. Electron Work Function .....	27
6.3. Fermi Energy .....	28
6.4. Frontier Orbital Concept .....	30
7. Interactions on Solid Surfaces .....	32
7.1. Interactions Between Two Discrete Molecules .....	32

7.2. Interactions Between a Molecule and a Solid . . . . .	32
7.3. Chemisorption . . . . .	33
8. Hard–Soft Acid–Base (HSAB) Principle . . . . .	33
8.1. The HSAB Principle in Solution . . . . .	33
8.2. Extension of the HSAB Principle to the Solid State . . . . .	34
9. Metal-to-Metal Contact . . . . .	35
9.1. Metal–Metal Adhesion . . . . .	36
9.2. Metal–Metal Adhesion Theory . . . . .	36
9.3. Effect of Critical Separation on Metal–Metal Adhesion . . . . .	36
9.4. Effect of the Acid–Base Interaction on Metal–Metal Adhesion . . . . .	37
9.5. Effect of Crystal Structure on Metal–Metal Adhesion . . . . .	37
9.6. Effect of Contact Electrification on Metal–Metal Adhesion . . . . .	38
9.7. Effect of Diffusion on Metal–Metal Adhesion . . . . .	38
10. Metal–Semiconductor Contact . . . . .	39
10.1. Ionicity of Semiconductors . . . . .	40
10.2. Metal–Semiconductor Adhesion . . . . .	41
10.3. Effect of Chemical Reaction on Metal–Semiconductor Interface . . . . .	41
10.4. Effect of Contact Electrification on Metal–Semiconductor Adhesion . . . . .	42
11. Metal–Salt and Metal–Oxide Adhesion . . . . .	45
12. Metal–Ceramic Adhesion . . . . .	46
13. Metal–Superconductor Adhesion . . . . .	48
14. Metal–Glass Adhesion . . . . .	48
15. Metal–Diamond Adhesion . . . . .	49
16. Metal–Polymer Adhesion . . . . .	50
16.1. Mechanisms of Metal–Polymer Adhesion . . . . .	50
16.2. Classification of Polymers According to their Wettabilities . . . . .	50
16.3. Metal Adhesion to Low Wettability Polymers . . . . .	51
16.4. Metal Adhesion of Medium Wettability Polymers . . . . .	55
16.5. Metal Adhesion to High Wettability Polymers . . . . .	56
16.6. Metal–Rubber Adhesion . . . . .	60
16.7. Effect of Contact Electrification on Metal–Polymer Adhesion . . . . .	62
17. Polymer–Solid Adhesion . . . . .	63
17.1. Polymer–Solid Contact . . . . .	64
17.2. Polymers as Adhesives . . . . .	66
18. Discussion . . . . .	67
19. Summary . . . . .	71
Appendix . . . . .	72
A. Fundamental Physical Constants . . . . .	72
B. Non-SI Units Used with SI . . . . .	72
Acknowledgment . . . . .	72

Nomenclature .....	73
References .....	75

## 2. Thermodynamics of Adhesion

*W. Gutowski*

1. Molecular Forces .....	87
1.1. General .....	87
1.2. Types of Intermolecular and Interatomic Forces, Their Range and Magnitude .....	87
1.3. Classical (Microscopic) Theory of Interatomic and Intermolecular Forces .....	89
1.4. Application of Quantum Field Theory for Estimation of Interaction Force and Energy Between Two Solids (Macroscopic Theory) .....	98
2. Acid–Base (Donor–Acceptor) Interactions .....	105
2.1. Brønsted and Lewis Concepts of Acid–Base Interactions .....	105
2.2. Acidity and Basicity of Solid Surfaces .....	106
2.3. Quantitative Assessment of Acid–Base Interactions .....	109
2.4. Acid–Base Interactions in Adhesion .....	113
3. Thermodynamics of Surfaces .....	116
3.1. Surface Energy, Thermodynamic Work of Adhesion, and Energy of Cohesion .....	116
3.2. Energy Equilibrium at the Interface .....	117
3.3. Interfacial Energy .....	118
4. Experimental Techniques .....	123
4.1. Interfacial Energy at the Liquid–Liquid and Liquid–Gas Interface by Techniques Independent of Contact Angle .....	124
4.2. Techniques Based on Measurement of the Equilibrium Contact Angle .....	140
4.3. Techniques Based on Acid–Base Interaction Concepts .....	131
Nomenclature .....	132
References .....	133

## 3. Theory of Adhesive Forces Across Interfaces: 1. The Lifshitz–van der Waals Component of Interaction and Adhesion

*Robert J. Good and Manoj K. Chaudhury*

1. Introduction .....	137
2. Theory of van der Waals Interactions Across Interfaces .....	137
2.1. The Pairwise-Addition Approximation .....	137
2.2. The Lifshitz Theory: General Considerations .....	140

3. Interactions Between Condensed Phases .....	142
4. Application to Interfacial Tension and Free Energy .....	145
Appendix. A Note on Electrostatic and Electromagnetic Units in the Theory of Adhesion .....	147
Nomenclature .....	149
References .....	150

#### **4. Theory of Adhesive Forces Across Interfaces: 2. Interfacial Hydrogen Bonds as Acid–Base Phenomena and as Factors Enhancing Adhesion**

*Robert J. Good, Manoj K. Chaudhury, and Carel J. van Oss*

1. Introduction .....	153
2. Monopolar and Bipolar Substances and Hydrogen Bonds <i>per se</i> .....	154
3. Classification of Binary Systems .....	157
4. Surface Parameters $\gamma^{\oplus}$ and $\gamma^{\ominus}$ That Give Direct Characterization of Acidic and Basic Behavior .....	160
5. Application of the Lewis Acid–Base Parameters .....	162
5.1. $\gamma^{\oplus}$ and $\gamma^{\ominus}$ Values of Selected Liquids .....	163
5.2. Application to Selected Solid Surfaces .....	164
5.3. Discussion of $\gamma^{\oplus}$ and $\gamma^{\ominus}$ Values in Table 5 .....	165
6. An Anomaly .....	167
7. Applications .....	167
7.1. Negative Interfacial Tensions: An Illustration .....	167
7.2. Application to Adhesion and Adhesive Bonding .....	168
7.3. The Effective Range of Acid–Base Interactions .....	169
7.4. Other Developments and Applications .....	169
8. Summary .....	170
Nomenclature .....	170
References .....	171

#### **5. The Dynamics of Wetting**

*P. G. de Gennes*

1. Introduction .....	173
2. The Final State in Complete Wetting .....	174
3. The Dynamics of Dry Spreading .....	175
4. Special Systems .....	177
4.1. Polymer Melts .....	177
4.2. Langmuir–Blodgett Deposition .....	177
5. Conclusions .....	178
Acknowledgments .....	178
Nomenclature .....	178
References .....	179

## 6. Kinetics of Polymer–Polymer Interdiffusion

### *F. Brochard-Wyart*

1.	Introduction .....	181
1.1.	Interdiffusion Coefficient .....	181
1.2.	Interdiffusion Profiles .....	186
2.	Dynamics of Pure Melts—Autoadhesion .....	188
2.1.	Polymer Melts: Statics and Dynamics .....	189
2.2.	Reptation and Self-Diffusion of Entangled Polymers .....	190
2.3.	Interdiffusion of Labeled $P_A^*$ /Unlabeled $P_A$ Polymers .....	191
2.4.	Autoadhesion: Polymer–Polymer Welding .....	193
3.	Dynamics of $P_A/P_B$ Mixtures: Heterojunctions .....	196
3.1.	The Flory–Huggins Free Energy of Mixing .....	196
3.2.	Microscopic Theory of Mutual Diffusion .....	197
3.3.	Interdiffusion of Small Chains ( $N_A, N_B < N_c$ ) .....	199
3.4.	Interdiffusion of Entangled Polymers ( $N_A, N_B > N_c$ ) .....	201
3.5.	$P_A/P_B$ Welding (Short-Time Behavior) .....	202
4.	Conclusions .....	202
	Acknowledgments .....	203
	Nomenclature .....	204
	References .....	204

## 7. Welding, Tack, and Green Strength of Polymers

### *Richard P. Wool*

1.	Introduction .....	207
2.	Theory .....	208
2.1.	Molecular Dynamics of Random-Coil Chains .....	208
2.2.	Molecular Description of a Polymer–Polymer Interface .....	209
2.3.	Concentration Profile .....	214
2.4.	Scaling Laws for a Polymer–Polymer Interface .....	215
3.	Fractal Nature of a Diffusion Front .....	216
3.1.	Atomic Diffusion Front .....	216
3.2.	Computer Analysis of Polymer–Polymer Interdiffusion .....	218
4.	Microstructural Fracture Criteria .....	220
4.1.	Chain Pullout .....	220
4.2.	Fracture Mechanics of Welding .....	222
4.3.	Stages of Healing .....	227
5.	Healing Experiments .....	229
5.1.	Tack and Green Strength .....	229
6.	Welding of Polymer Interfaces .....	233
6.1.	Wedge Cleavage Experiment .....	233
7.	Lap Shear Welding .....	241
7.1.	Polystyrene Welding .....	241

8. Polymer Processing Weld Lines .....	242
8.1. Compression Molding .....	242
Acknowledgments .....	244
Nomenclature .....	244
References .....	246

## 8. Role of Electrostatics in Adhesion

*Dan A. Hays*

1. Introduction .....	249
2. Electrostatic Concepts .....	251
3. Electrostatic Force Between a Point Charge and Planar Material .....	253
4. Electrostatic Force Between Charged Planar Materials .....	254
5. Charge Exchange Properties of Materials .....	258
5.1. Metal–Metal Charging .....	259
5.2. Metal–Insulator Charging .....	261
5.3. Insulator–Insulator Charging .....	265
6. Charge Penetration Depth in Insulators .....	266
7. Charge Back-Flow During Separation .....	268
8. Interfacial Polarization .....	269
9. Charged Particle Adhesion .....	270
10. Summary .....	275
Nomenclature .....	275
References .....	276

## 9. Adhesion Through Silane Coupling Agents

*Edwin P. Plueddemann*

1. Introduction .....	279
2. General Equilibrium Conditions .....	280
2.1. Reaction with the Mineral .....	281
2.2. Hydrophobic Interphase Region .....	281
2.3. Optimum Structure in the Interphase Region .....	282
3. Crosslinking the Interphase Region .....	285
3.1. Inhibition of Cure by Fillers .....	285
3.2. Inhibition of Cure by Silanes .....	286
3.3. Additional Crosslinking Through the Coupling Agent .....	286
3.4. Additional Crosslinking Through Siliconates .....	287
4. Conclusion .....	289
References .....	289

## 10. Adhesive–Adherend Interface and Interphase

*James D. Miller and Hatsuo Ishida*

1. Introduction .....	291
2. Interface .....	292

3.	Chemical Modifiers .....	297
4.	Evidence of Chemical Bonding .....	302
5.	Interphase .....	308
5.1.	Theories .....	308
5.2.	Properties .....	310
5.3.	Silane Interphase .....	314
5.4.	Other Additives .....	318
6.	Future Directions .....	319
	References .....	320

## 11. Adhesion at Metal Interfaces

*Amitava Banerjea, John Ferrante, and John R. Smith*

1.	Introduction .....	325
2.	Theoretical Considerations .....	327
2.1.	First-Principle Calculations .....	328
2.2.	Jellium-Model Calculations .....	329
3.	Binding Energies .....	333
3.1.	Fully Three-Dimensional Calculations .....	335
3.2.	Universality in the Shapes of the Binding Energy Curves .....	337
4.	Semiempirical Techniques .....	338
4.1.	Embedded-Atom Method .....	338
4.2.	Equivalent-Crystal Theory .....	339
5.	Concluding Remarks .....	345
	Nomenclature .....	346
	References .....	347

## 12. Hard–Soft Acid–Base (HSAB) Principle for Solid Adhesion and Surface Interactions

*Lieng-Huang Lee*

1.	Introduction .....	349
2.	HSAB Principle .....	349
2.1.	HSAB Principle for Inorganic Reactions .....	349
2.2.	HSAB Principle for Organic Reactions and the Frontier Orbital Approach .....	350
2.3.	Perturbation Equation .....	350
2.4.	Electronegativity and Absolute Hardness .....	351
3.	Extension of the HSAB Principle to Solid Interactions .....	353
3.1.	Electronic Band Structures of Solids .....	353
3.2.	Average Energy Gap and Absolute Hardness .....	354
3.3.	Energy Gaps and Absolute Hardness Values for Semiconductors .....	354
3.4.	Absolute Hardness of Solid .....	357

4. Applications of the HSAB Principle to Adhesion and Surface Interactions Between Metals and Polymers .....	358
5. Conclusions .....	359
Acknowledgments .....	359
Nomenclature .....	360
References .....	360

## 13. Interface Design for Thin Film Adhesion

*John E. E. Baglin*

1. Introduction .....	363
2. Origins of Thin Film Adhesion .....	364
2.1. Interface Energy .....	364
2.2. Interface Fracture .....	365
3. Adhesion Performance .....	366
3.1. Dependence on Application .....	366
3.2. Adhesion Measurements .....	367
4. Adhesion Enhancement .....	370
4.1. Processing Strategies .....	370
4.2. Ion Beam Techniques .....	371
5. Summary .....	381
References .....	381

## 14. Chemistry, Microstructure, and Adhesion of Metal–Polymer Interfaces

*Paul S. Ho, Richard Haight, Robert C. White, B. D. Silverman, and F. Faupel*

1. Introduction .....	383
2. Chemical Bonding and Electronic Structure .....	385
2.1. Electronic Structure of Polyimide Surface .....	385
2.2. Chromium–Polyimide Interface .....	388
2.3. Copper–Polyimide Interface .....	391
3. Interfacial Microstructure .....	393
4. Adhesion and Deformation .....	399
5. Summary .....	404
Acknowledgments .....	405
References .....	405

## 15. Aspects of Bioadhesion

*Robert E. Baier and Anne E. Meyer*

1. Introduction .....	407
2. Analytical Methods Most Applicable to Bioadhesion Studies .....	409

3. Experimental Requirements .....	410
4. Bioadhesion of Microbes .....	410
5. Bioadhesion of Macrobiota .....	415
6. Bioadhesion from Blood .....	415
7. Bioadhesion in Hard and Soft Tissues .....	417
8. Research Priorities for Future Bioadhesion Studies .....	419
9. Summary and Conclusions .....	420
10. Postscript: Universality of the Principle of Bioadhesion .....	421
Acknowledgments .....	422
References .....	422
 <b>About the Contributors</b> .....	427
 <b>Author Index</b> .....	431
 <b>Subject Index</b> .....	437